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Vishay Siliconix

Automotive Dual N-Channel 40 V (D-S) 175 °C MOSFETs

PRODUCT SUMMARY							
N-CHANNEL 1 N-CHANNEL							
V _{DS} (V)	40	40					
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0.0160	0.0064					
$R_{DS(on)}$ (Ω) at $V_{GS} = 4.5 \text{ V}$	0.0188	0.0076					
I _D (A)	15	18					
Configuration	Dual N						

FEATURES

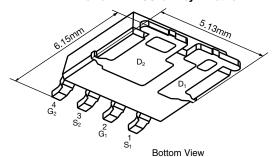
- TrenchFET® Power MOSFET
- AEC-Q101 Qualified^d
- 100 % R_a and UIS Tested
- Material categorization:
 For definitions of compliance please see www.vishay.com/doc?99912

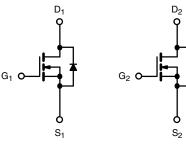




ROHS COMPLIANT HALOGEN FREE

PowerPAK® SO-8L Asymmetric





N-Channel 1 MOSFET

N-Channel 2 MOSFET

ORDERING INFORMATION	
Package	PowerPAK SO-8L Dual Asymmetric
Lead (Pb)-free and Halogen-free	SQJ940EP-T1-GE3

ABSOLUTE MAXIMUM RATINGS (T	_C = 25 °C, unless	otherwise n	oted)			
PARAMETER	SYMBOL	N-CHANNEL 1	N-CHANNEL 2	UNIT		
Drain-Source Voltage		V _{DS}	40	40	V	
Gate-Source Voltage	V_{GS}	±	V			
Continuous Duoin Currents	T _C = 25 °C		15	18		
Continuous Drain Current ^a	T _C = 125 °C	l _D	15	10.5		
Continuous Source Current (Diode Conduction) ^a		I _S	15	39	Α	
Pulsed Drain Current ^b		I _{DM}	60	72		
Single Pulse Avalanche Current	Avalanche Current		20.5	35.5		
Single Pulse Avalanche Energy	ngle Pulse Avalanche Energy L = 0.1 mH		21	63	mJ	
Maximum Power Dissipation ^b	T _C = 25 °C	D	48	43	W	
Maximum Power Dissipation	T _C = 125 °C	P_{D}	16	14	VV	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 175		00	
Soldering Recommendations (Peak Temperature) ^{e, f}			260		°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	N-CHANNEL 1	N-CHANNEL 2	UNIT
Junction-to-Ambient	PCB Mount ^c	R_{thJA}	70	70	°C/W
Junction-to-Case (Drain)		R_{thJC}	3.3	3.5	C/VV

Notes

- a. Package limited.
- b. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%.$
- c. When mounted on 1" square PCB (FR4 material).
- d. Parametric verification ongoing.
- e. See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- f. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.



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PARAMETER	SYMBOL		TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT			
Static							L			
Durin Command Dural day of Walliam	.,	V _{GS} =	N-Ch 1	40	-	_	- V			
Drain-Source Breakdown Voltage	V_{DS}	V _{GS} =	N-Ch 2	40	-	-				
Oak Oarras Three hald Walliam	.,	V _{DS} =	N-Ch 1	1.5	2	2.5				
Gate-Source Threshold Voltage	$V_{GS(th)}$	V _{DS} =	- V _{GS} , I _D = 250 μA	N-Ch 2	1.5	2	2.5	1		
Coto Courso Lookaga			0.77.77	N-Ch 1	-	-	± 100	nA		
Gate-Source Leakage	I _{GSS}	v _{DS} =	$0 \text{ V}, \text{ V}_{GS} = \pm 20 \text{ V}$	N-Ch 2	-	-	± 100			
		$V_{GS} = 0 V$	V _{DS} 40 V	N-Ch 1	-	-	1			
		V _{GS} = 0 V	V _{DS} = - 40 V	N-Ch 2	-	-	1	1		
Zana Oata Valtana Busin Commant		V _{GS} = 0 V	V _{DS} = 40 V, T _J = 125 °C	N-Ch 1	-	-	50			
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V	V _{DS} = 40 V, T _J = 125 °C	N-Ch 2	-	-	50	μA		
		V _{GS} = 0 V	V _{DS} = 40 V, T _J = 175 °C	N-Ch 1	-	-	150	1		
		V _{GS} = 0 V	V _{DS} = 40 V, T _J = 175 °C	N-Ch 2	-	-	150	1		
		V _{GS} = 10 V	$V_{DS} \ge 5 \text{ V}$	N-Ch 1	30	-	-	А		
On-State Drain Current ^a	I _{D(on)}	V _{GS} = 10 V	V _{DS} ≥ 5 V	N-Ch 2	30	-	-			
		V _{GS} = 10 V	I _D = 15 A	N-Ch 1	-	0.0133	0.0160			
		V _{GS} = 10 V	I _D = 20 A	N-Ch 2	-	0.0053	0.0064	Ω		
	R _{DS(on)}	V _{GS} = 10 V	I _D = 15 A, T _J = 125 °C	N-Ch 1	-	-	0.0270			
		V _{GS} = 10 V	I _D = 20 A, T _J = 125 °C	N-Ch 2	-	-	0.0105			
Drain-Source On-State Resistance ^a		V _{GS} = 10 V	I _D = 15 A, T _J = 175 °C	N-Ch 1	-	-	0.0334			
		V _{GS} = 10 V	I _D = 20 A, T _J = 175 °C	N-Ch 2	-	-	0.0130			
		V _{GS} = 4.5 V	I _D = 13 A	N-Ch 1	-	0.0157	0.0188	1		
		V _{GS} = 4.5 V	I _D = 18 A	N-Ch 2	-	0.0063	0.0076	1		
		•	= 15 V, I _D = 15 A	N-Ch 1	-	64	-			
Forward Transconductance ^b	9 _{fs}	V _{DS}	= 15 V, I _D = 20 A	N-Ch 2	-	102	-	S		
Dynamic ^b						L	l			
		V _{GS} = 0 V	V _{DS} = 20 V, f = 1 MHz	N-Ch 1	-	717	896			
Input Capacitance	C_{iss}	V _{GS} = 0 V	V _{DS} = 20 V, f = 1 MHz	N-Ch 2	-	1850	2313	1		
		V _{GS} = 0 V	V _{DS} = 20 V, f = 1 MHz	N-Ch 1	-	118	148	1 _		
Output Capacitance	C_{oss}	V _{GS} = 0 V	V _{DS} = 20 V, f = 1 MHz	N-Ch 2	-	272	340	pF		
	_	V _{GS} = 0 V	V _{DS} = 20 V, f = 1 MHz	N-Ch 1	-	48	60	1		
Reverse Transfer Capacitance	C_{rss}	V _{GS} = 0 V	V _{DS} = 20 V, f = 1 MHz	N-Ch 2	-	98	123	1		
		V _{GS} = 10 V	$V_{DS} = 20 \text{ V}, I_{D} = 6 \text{ A}$	N-Ch 1	-	13.5	20			
Total Gate Charge ^c	Q_g	V _{GS} = 10 V	V _{DS} = 20 V, I _D = 16 A	N-Ch 2	-	31.8	48	1		
	Q _{gs}	V _{GS} = 10 V	V _{DS} = 20 V, I _D = 6 A	N-Ch 1	-	2.24	_	nC		
Gate-Source Charge ^c		V _{GS} = 10 V	$V_{DS} = 20 \text{ V}, I_D = 16 \text{ A}$	N-Ch 2	-	5.5	-	- '''		
	Q _{gd}	V _{GS} = 10 V	$V_{DS} = 20 \text{ V}, I_{D} = 6 \text{ A}$	N-Ch 1	-	2.06	-	1		
Gate-Drain Charge ^c				N-Ch 2	-	4.7	-	1		
				N-Ch 1	1.2	2.52	5			
Gate Resistance	R_g	f = 1 MHz		N-Ch 2	3	7.93	13	Ω		

Notes

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.



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SPECIFICATIONS (T _C = 25 °C, unless otherwise noted)								
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
T 0 0 1 T 0	+	$\begin{aligned} V_{DD} &= 20 \text{ V}, \text{ R}_L = 20 \Omega \\ I_D &\cong 1 \text{ A}, \text{ V}_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega \end{aligned}$	N-Ch 1	ı	4.8	7.2		
Turn-On Delay Time ^c	t _{d(on)}	$V_{DD} = 20 \text{ V}, R_L = 20 \Omega$ $I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$ N-Ch 2		ı	7.7	11.6		
Rise Time ^c	+	$\begin{aligned} V_{DD} &= 20 \text{ V}, \text{ R}_L = 20 \Omega\\ I_D &\cong 1 \text{ A}, \text{ V}_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega \end{aligned}$	N-Ch 1	ı	9.3	14	ns	
nise tiitile	t _r	$\begin{aligned} V_{DD} &= 20 \text{ V}, \text{ R}_L = 20 \Omega\\ I_D &\cong 1 \text{ A}, \text{ V}_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega \end{aligned}$	N-Ch 2	ı	9.5	14.3		
Turn-Off Delay Time ^c	t _{d(off)}	$\begin{aligned} V_{DD} &= 20 \text{ V}, \text{ R}_L = 20 \Omega\\ I_D &\cong 1 \text{ A}, \text{ V}_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega \end{aligned}$	N-Ch 1	ı	15.6	23.4		
Turn-Oil Delay Times		$\begin{aligned} V_{DD} &= 20 \text{ V}, \text{ R}_L = 20 \Omega\\ I_D &\cong 1 \text{ A}, \text{ V}_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega \end{aligned}$	N-Ch 2	-	47	70		
Foll Times		$\begin{aligned} V_{DD} &= 20 \text{ V}, \text{ R}_L = 20 \Omega\\ I_D &\cong 1 \text{ A}, \text{ V}_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega \end{aligned}$	N-Ch 1	-	4.9	7.4		
Fall Time ^c	t _f	$\begin{aligned} V_{DD} &= 20 \text{ V}, \text{ R}_L = 20 \Omega\\ I_D &\cong 1 \text{ A}, \text{ V}_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega \end{aligned}$	N-Ch 2	-	13.5	20.3	-	
Source-Drain Diode Ratings and Characteristics ^b								
Pulsed Current ^a	I _{SM}	_	N-Ch 1	i	-	60	Α	
i dised Odiferit			N-Ch 2	ı	-	72		
Forward Voltage	V _{SD}	$I_F = 8 \text{ A}, V_{GS} = 0 \text{ V}$ N-Ch 1		i	0.8	1.2	V	
		$I_F = 17 \text{ A}, V_{GS} = 0 \text{ V}$	ı	0.8	1.2	v		

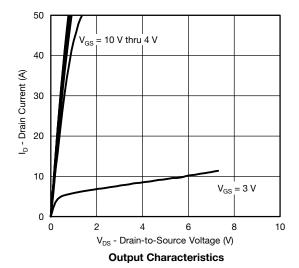
Notes

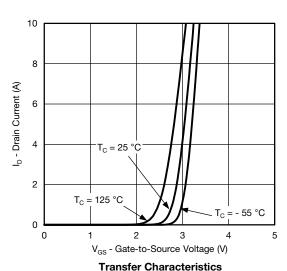
- a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

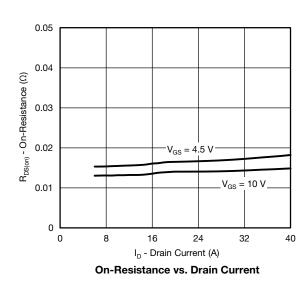
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

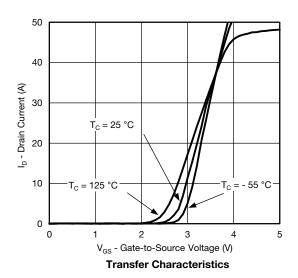


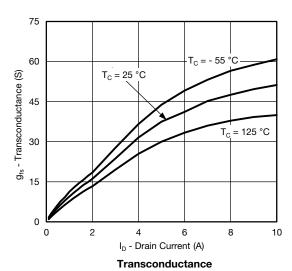
N-CHANNEL 1 TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)

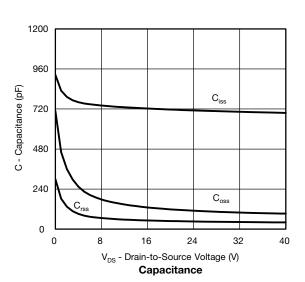






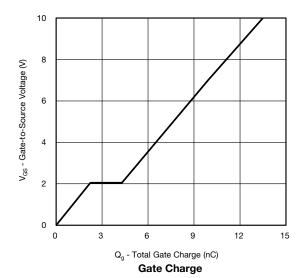


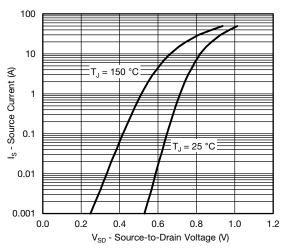




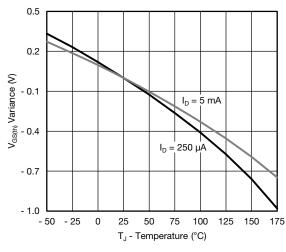


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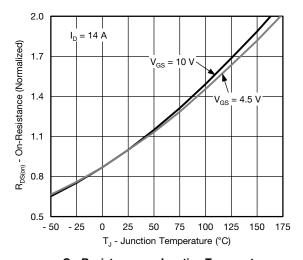




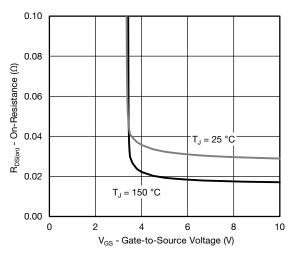
Source Drain Diode Forward Voltage



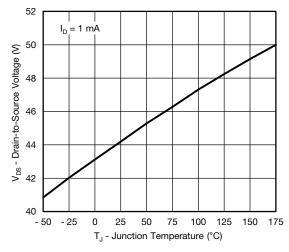
Threshold Voltage



On-Resistance vs. Junction Temperature



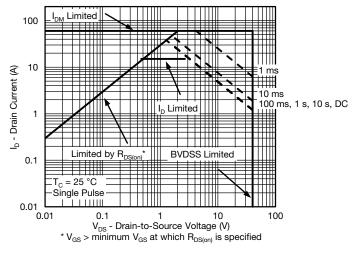
On-Resistance vs. Gate-to-Source Voltage



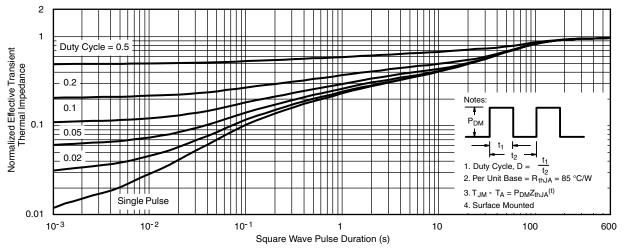
Drain Source Breakdown vs. Junction Temperature



N-CHANNEL 1 TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



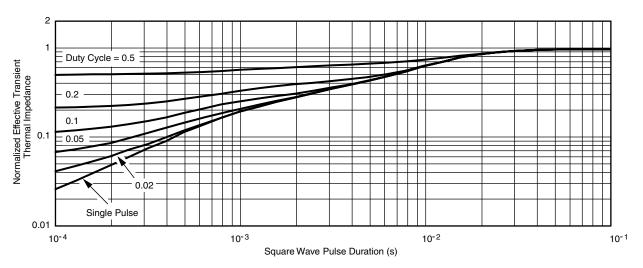
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient

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N-CHANNEL 1 TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



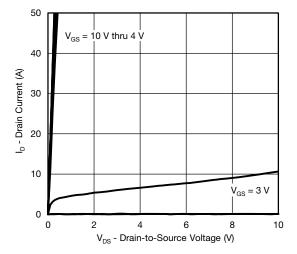
Normalized Thermal Transient Impedance, Junction-to-Case

Note

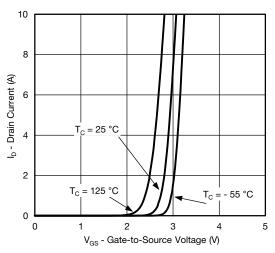
- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
- Normalized Transient Thermal Impedance Junction-to-Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.



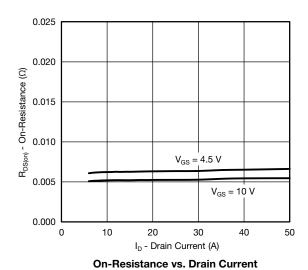
N-CHANNEL 2 TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



Output Characteristics

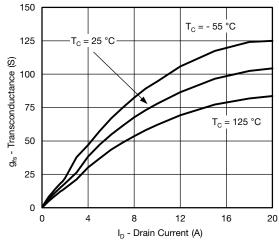


Transfer Characteristics

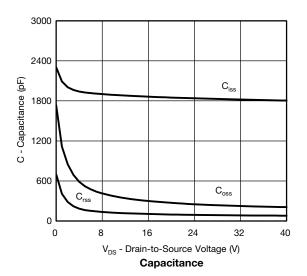


 $T_{\rm C} = 25 \, ^{\circ}{\rm C}$ 10 $T_{\rm C} = 125 \, ^{\circ}{\rm C}$ $T_{\rm C} = -55 \, ^{\circ}{\rm C}$

Transfer Characteristics

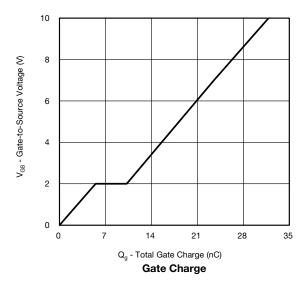


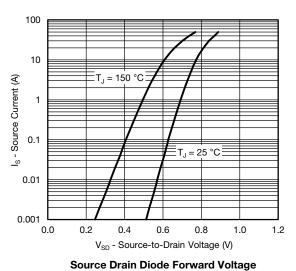
Transconductance

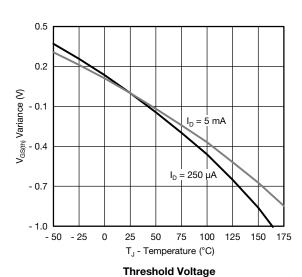


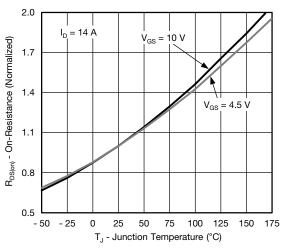


N-CHANNEL 2 TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)

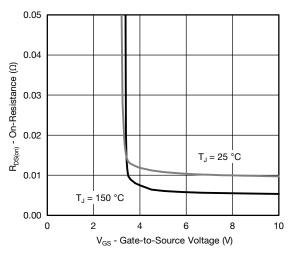




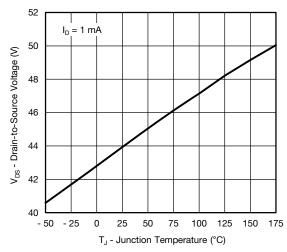




On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage

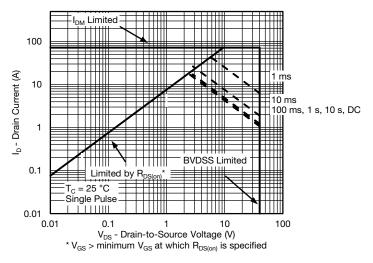


Drain Source Breakdown vs. Junction Temperature

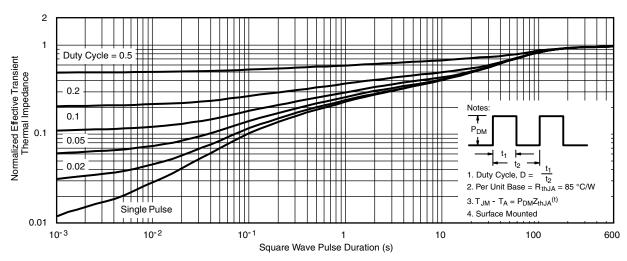
ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



N-CHANNEL 2 TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



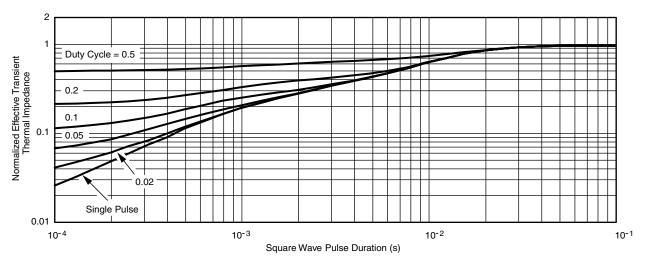
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient

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N-CHANNEL 2 TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

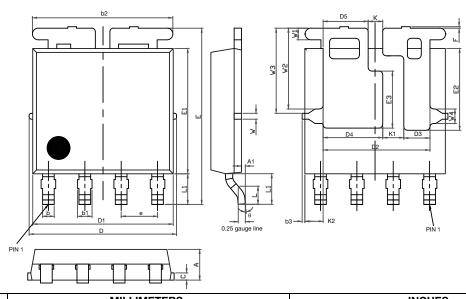
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Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62767.



PowerPAK® SO-8L Assymetric Case Outline



DIM.	MILLIMETERS			INCHES				
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
Α	1.00	1.07	1.14	0.039	0.042	0.045		
A1	0.00	0.06	0.13	0.000	0.003	0.005		
b	0.33	0.41	0.48	0.013	0.016	0.019		
b1	0.44	0.51	0.58	0.017	0.020	0.023		
b2	4.80	4.90	5.00	0.189	0.193	0.197		
b3	0.04	0.12	0.20	0.002	0.005	0.008		
С	0.20	0.25	0.30	0.008	0.010	0.012		
D	5.00	5.13	5.25	0.197	0.202	0.207		
D1	4.80	4.90	5.00	0.189	0.193	0.197		
D2	3.63	3.73	3.83	0.143	0.147	0.151		
D3	0.81	0.91	1.01	0.032	0.036	0.040		
D4	1.98	2.08	2.18	0.078	0.082	0.086		
D5	1.47	1.57	1.67	0.058	0.062	0.066		
е	1.20	1.27	1.34	0.047	0.050	0.053		
Е	6.05	6.15	6.25	0.238	0.242	0.246		
E1	4.27	4.37	4.47	0.168	0.172	0.176		
E2	2.75	2.85	2.95	0.108	0.112	0.116		
E3	1.89	1.99	2.09	0.074	0.078	0.082		
F	0.05	0.12	0.19	0.002	0.005	0.007		
L	0.62	0.72	0.82	0.024	0.028	0.032		
L1	0.92	1.07	1.22	0.036	0.042	0.048		
K	0.41	0.51	0.61	0.016	0.020	0.024		
K1	0.64	0.74	0.84	0.025	0.029	0.033		
K2	0.54	0.64	0.74	0.021	0.025	0.029		
W	0.13	0.23	0.33	0.005	0.009	0.013		
W1	0.31	0.41	0.51	0.012	0.016	0.020		
W2	2.72	2.82	2.92	0.107	0.111	0.115		
W3	2.86	2.96	3.06	0.113	0.117	0.120		
W4	0.41	0.51	0.61	0.016	0.020	0.024		
θ	5°	10°	12°	5°	10°	12°		

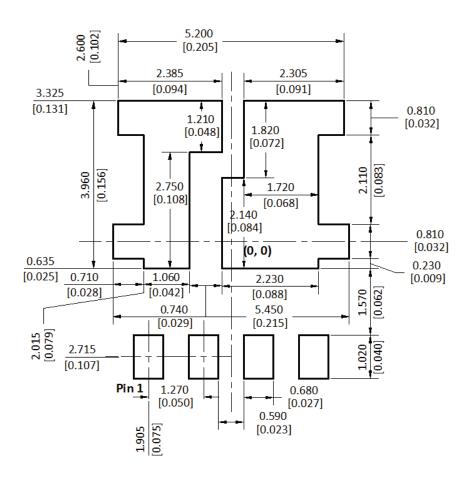
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Note

• Millimeters will govern



RECOMMENDED MINIMUM PADs FOR PowerPAK® SO-8L DUAL ASYMMETRIC



Recommended Minimum Pads Dimensions in mm [inches]



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Disclaimer

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